

## Complementary (N- and P-Channel) MOSFET

PRODUCT SUMMARY			
	V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)
N-Channel	30	0.018 at V <sub>GS</sub> = 10 V	8.8
		0.027 at V <sub>GS</sub> = 4.5 V	7.0
P-Channel	- 8	0.042 at V <sub>GS</sub> = - 4.5 V	- 5.7
		0.060 at V <sub>GS</sub> = - 2.5 V	- 4.8

### FEATURES

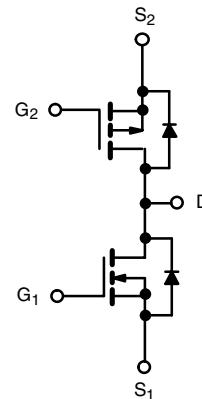
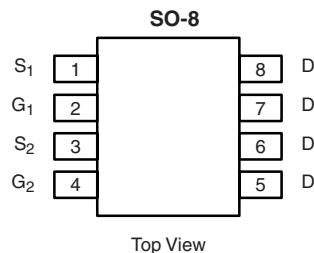
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC



**RoHS**  
COMPLIANT  
**HALOGEN**  
**FREE**  
Available

### APPLICATIONS

- Level Shift
- Load Switch



**Ordering Information:** Si4501ADY-T1-E3 (Lead (Pb)-free)  
Si4501ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

### ABSOLUTE MAXIMUM RATINGS T<sub>A</sub> = 25 °C, unless otherwise noted

Parameter	Symbol	N-Channel		P-Channel		Unit
		10 s	Steady State	10 s	Steady State	
Drain-Source Voltage	V <sub>DS</sub>		30		- 8	
Gate-Source Voltage	V <sub>GS</sub>		± 20		± 8	V
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a, b</sup>	I <sub>D</sub>	8.8	6.3	- 5.7	- 4.1	A
		7	5.2	- 4.5	- 3.3	
Pulsed Drain Current	I <sub>DM</sub>	30		- 30		
Continuous Source Current (Diode Conduction) <sup>a, b</sup>	I <sub>S</sub>	1.8	1.0	- 1.8	- 1.0	
Maximum Power Dissipation <sup>a, b</sup>	P <sub>D</sub>	2.5	1.3	2.5	1.3	W
		1.6	0.84	1.6	0.84	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150				°C

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	N-Channel		P-Channel		Unit
		Typ.	Max.	Typ.	Max.	
Maximum Junction-to-Ambient <sup>a</sup>	R <sub>thJA</sub>	40	50	42	50	°C/W
		75	95	76	95	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	18	23	21	26

Notes:

a. Surface Mounted on FR4 board.

b. t ≤ 10 s.

**SPECIFICATIONS**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions		Min.	Typ. <sup>a</sup>	Max.	Unit
<b>Static</b>							
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	N-Ch	0.8		1.8	V
		$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	P-Ch	- 0.45		- 1.0	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	N-Ch			$\pm 100$	nA
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	P-Ch			$\pm 100$	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch		1		$\mu\text{A}$
		$V_{DS} = -8 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch			- 1	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$	N-Ch			5	
		$V_{DS} = -8 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$	P-Ch			- 5	
On-State Drain Current <sup>b</sup>	$I_{D(\text{on})}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	30			A
		$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	P-Ch	- 20			
Drain-Source On-State Resistance <sup>b</sup>	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}, I_D = 8.8 \text{ A}$	N-Ch		0.015	0.018	$\Omega$
		$V_{GS} = -4.5 \text{ V}, I_D = -5.7 \text{ A}$	P-Ch		0.030	0.042	
		$V_{GS} = 4.5 \text{ V}, I_D = 7.0 \text{ A}$	N-Ch		0.022	0.027	
		$V_{GS} = -2.5 \text{ V}, I_D = -4.8 \text{ A}$	P-Ch		0.048	0.060	
Forward Transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} = 15 \text{ V}, I_D = 8.8 \text{ A}$	N-Ch		18		S
		$V_{DS} = -15 \text{ V}, I_D = -5.7 \text{ A}$	P-Ch		12		
Diode Forward Voltage <sup>b</sup>	$V_{SD}$	$I_S = 1.8 \text{ A}, V_{GS} = 0 \text{ V}$	N-Ch		0.73	1.1	V
		$I_S = -1.8 \text{ A}, V_{GS} = 0 \text{ V}$	P-Ch		- 0.75	- 1.1	
<b>Dynamic<sup>a</sup></b>							
Total Gate Charge	$Q_g$	N-Channel $V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 8.8 \text{ A}$ P-Channel $V_{DS} = -4 \text{ V}, V_{GS} = -5 \text{ V}, I_D = -5.7 \text{ A}$	N-Ch		11.5	20	nC
Gate-Source Charge	$Q_{gs}$		P-Ch		13.5	20	
Gate-Drain Charge	$Q_{gd}$		N-Ch		3		
Gate-Drain Charge	$Q_{gd}$		P-Ch		2.2		
Turn-On Delay Time	$t_{d(\text{on})}$	N-Channel $V_{DD} = 15 \text{ V}, R_L = 15 \Omega$ $I_D \approx 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 6 \Omega$	N-Ch		4		ns
Rise Time	$t_r$		P-Ch		3		
Turn-Off Delay Time	$t_{d(\text{off})}$		N-Ch		15	22	
Fall Time	$t_f$		P-Ch		21	40	
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = 1.8 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$	N-Ch		8	15	
			P-Ch		45	70	
		P-Channel $V_{DD} = -4 \text{ V}, R_L = 4 \Omega$ $I_D \approx -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_G = 6 \Omega$	N-Ch		35	50	
			P-Ch		60	100	
			N-Ch		10	20	
			P-Ch		55	85	
			N-Ch		30	60	
			P-Ch		50	100	

Notes:

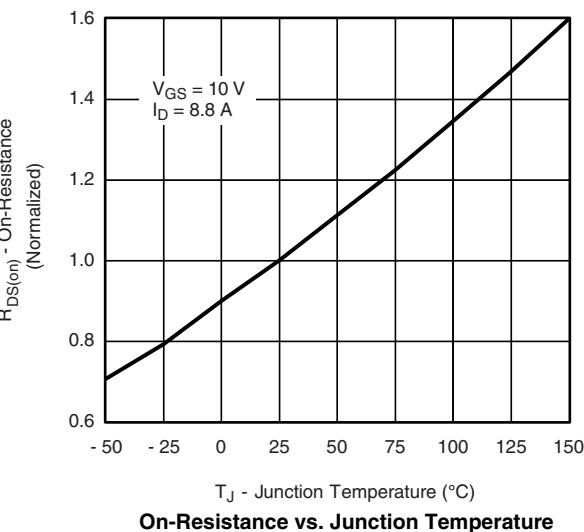
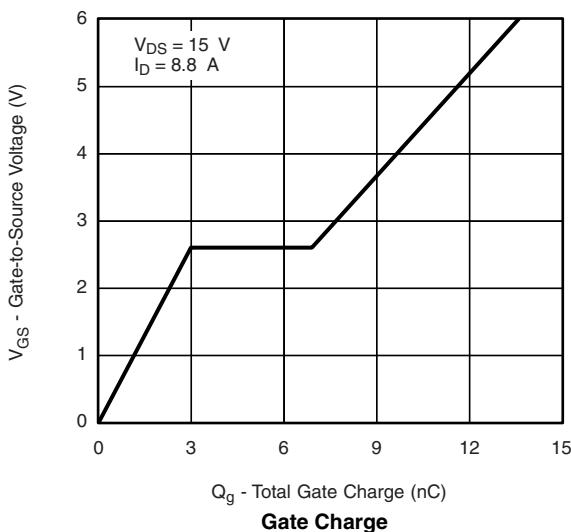
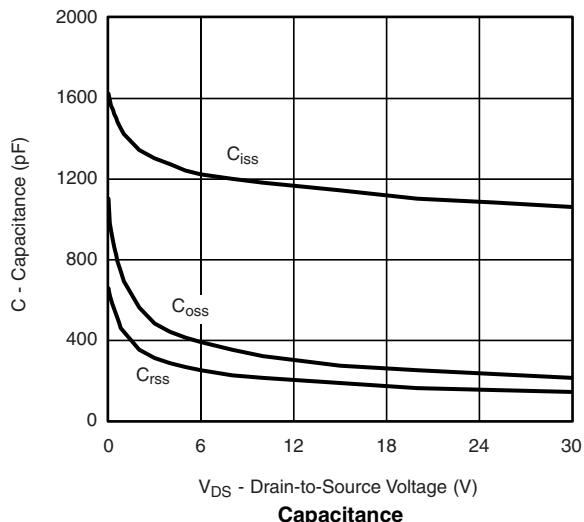
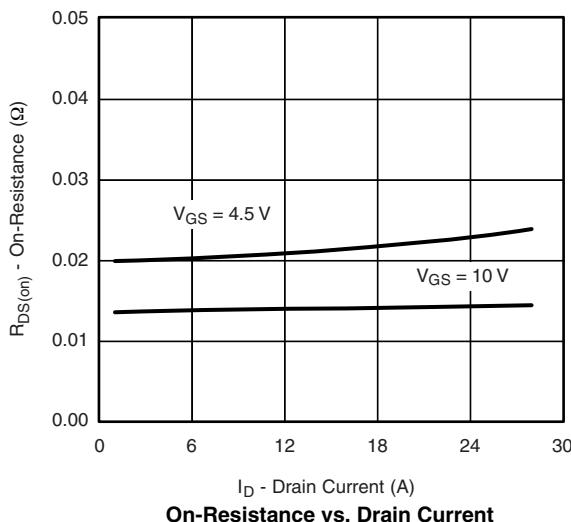
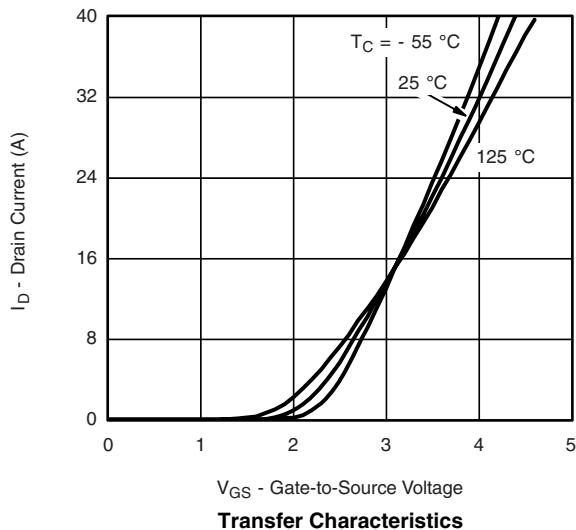
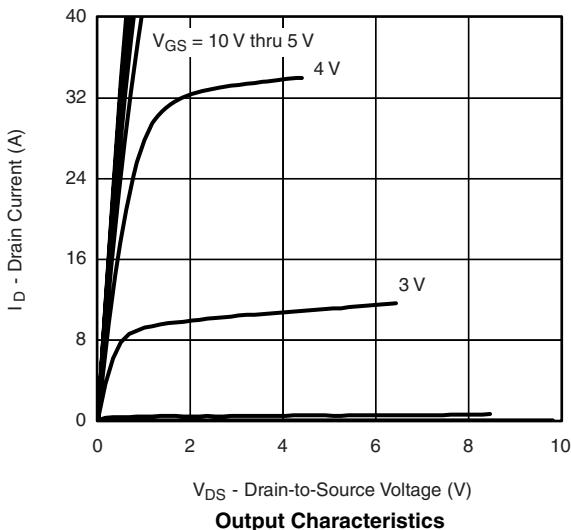
a. Guaranteed by design, not subject to production testing.

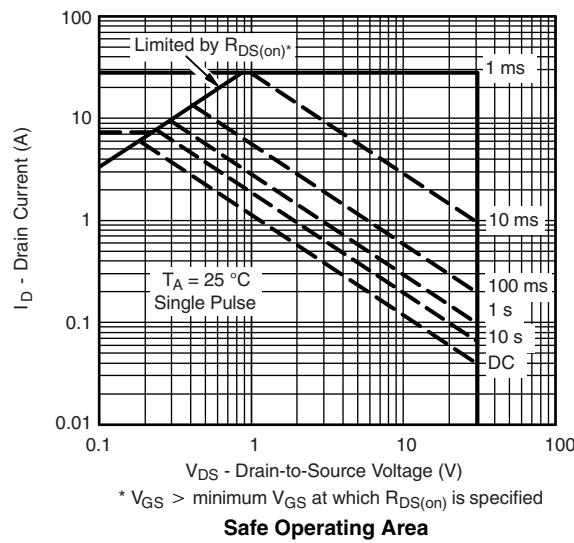
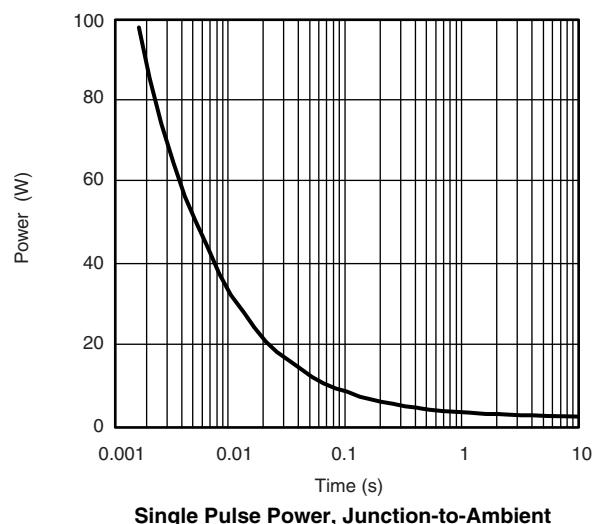
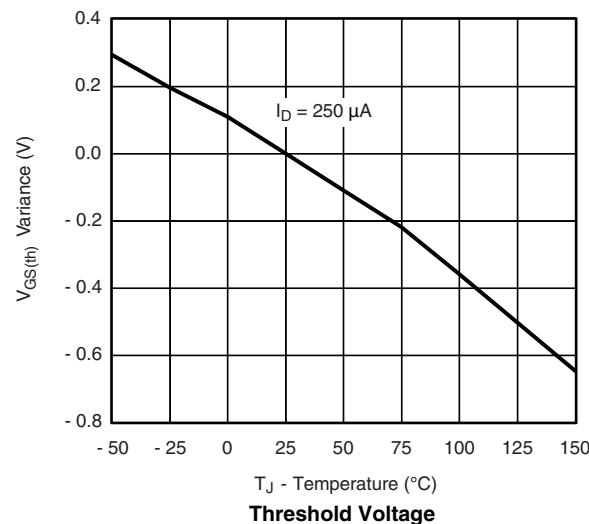
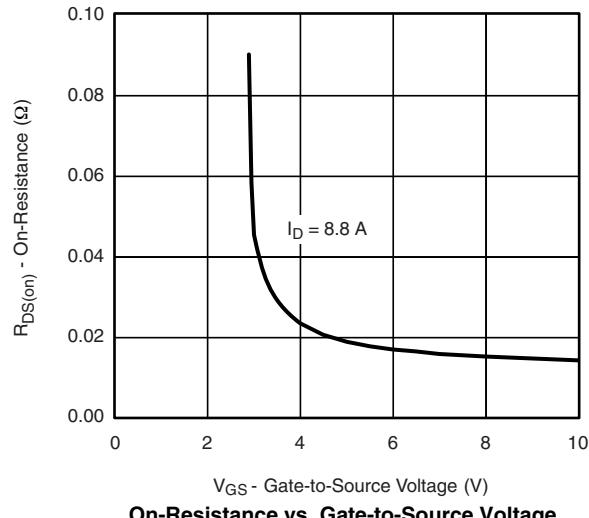
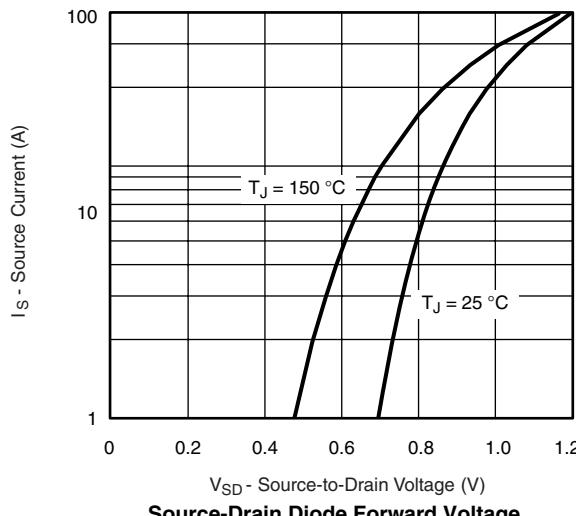
b. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

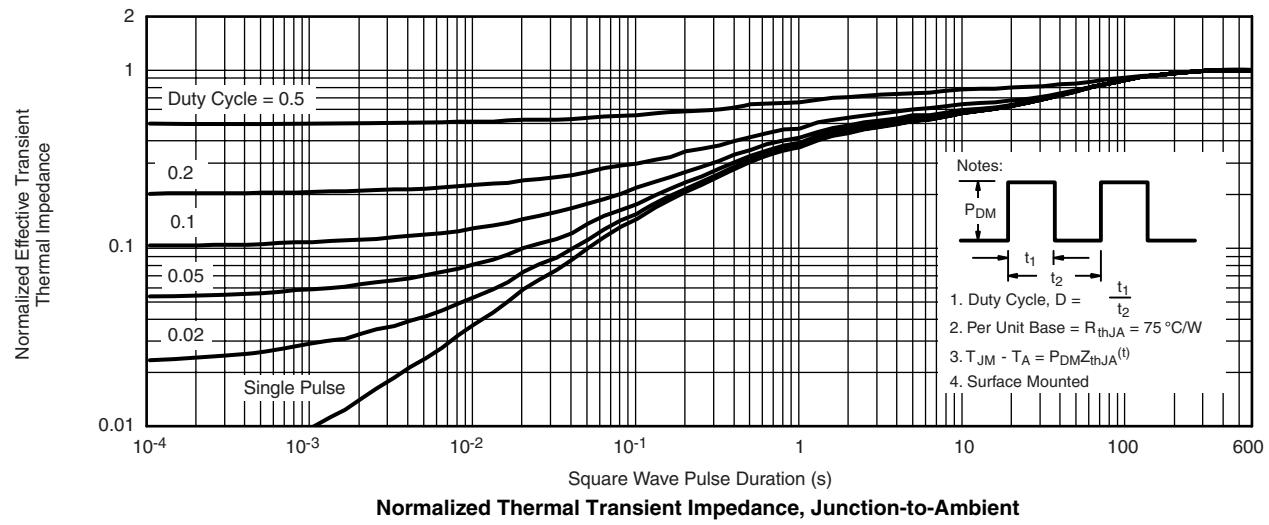
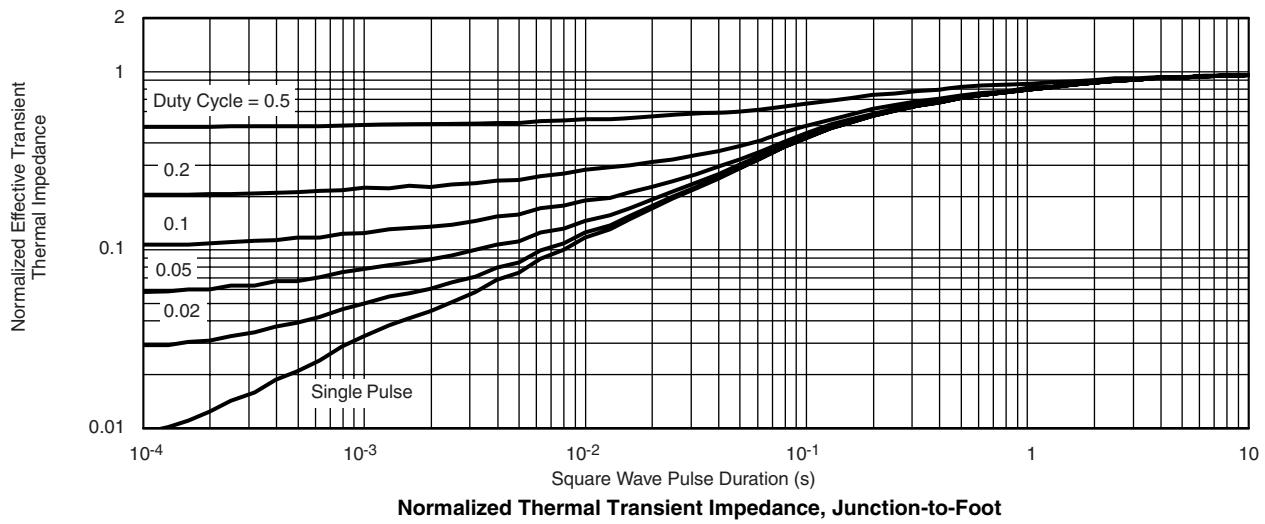
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

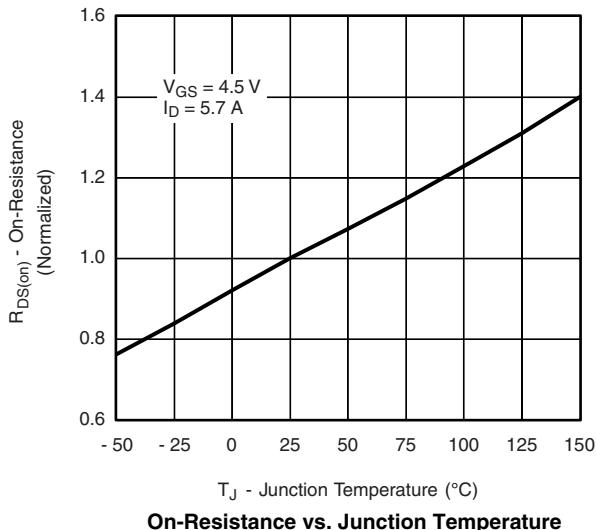
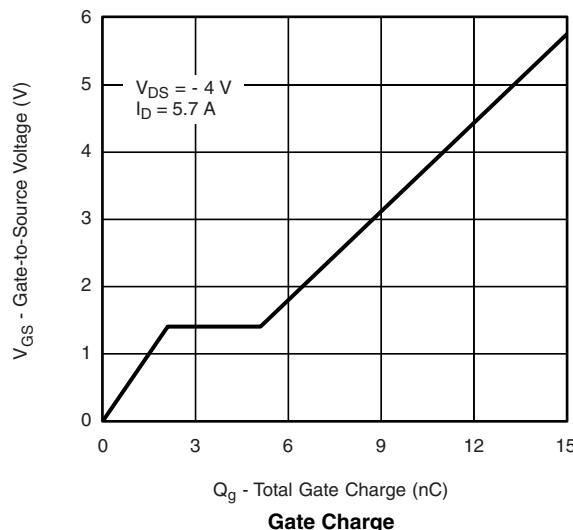
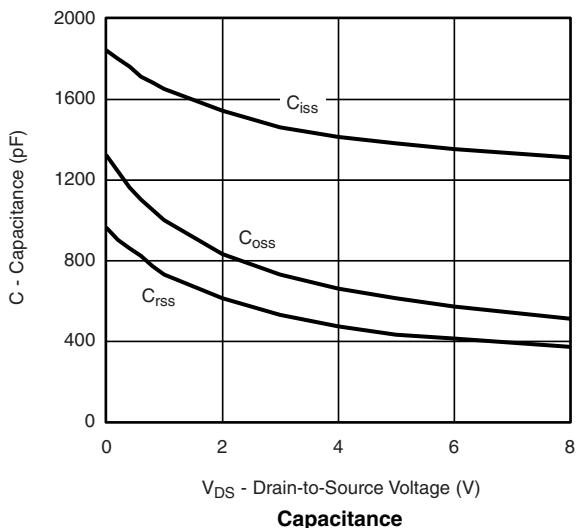
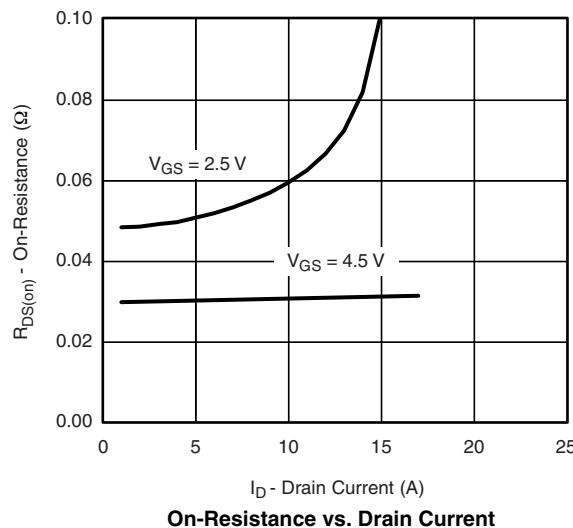
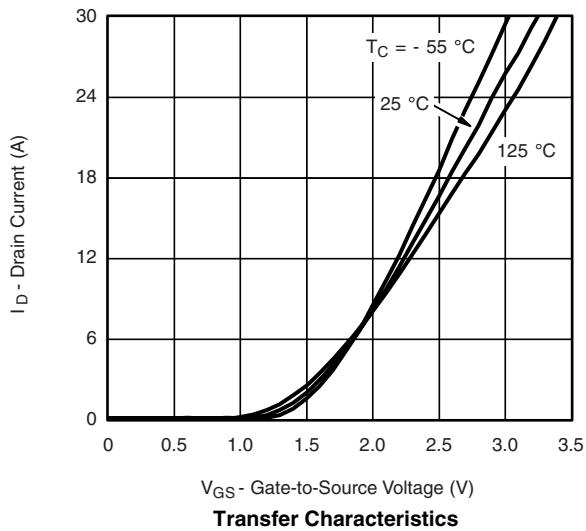
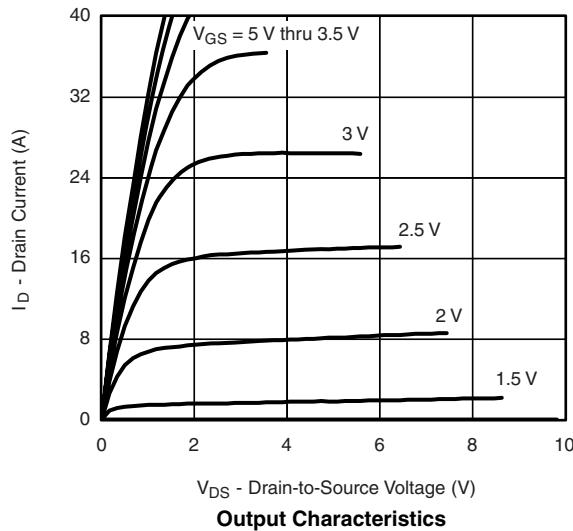
**N-CHANNEL TYPICAL CHARACTERISTICS**

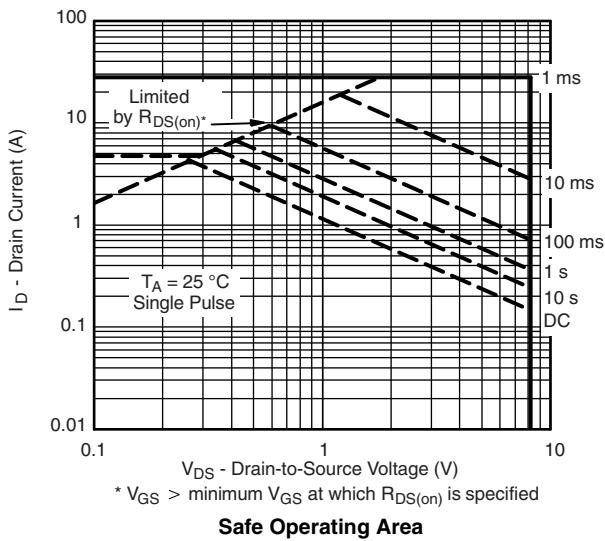
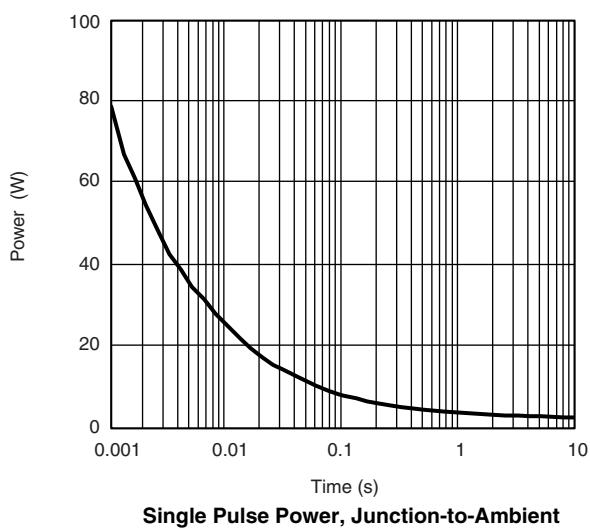
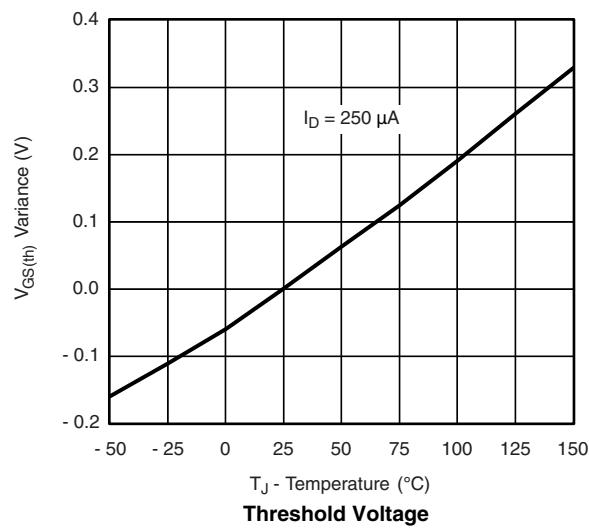
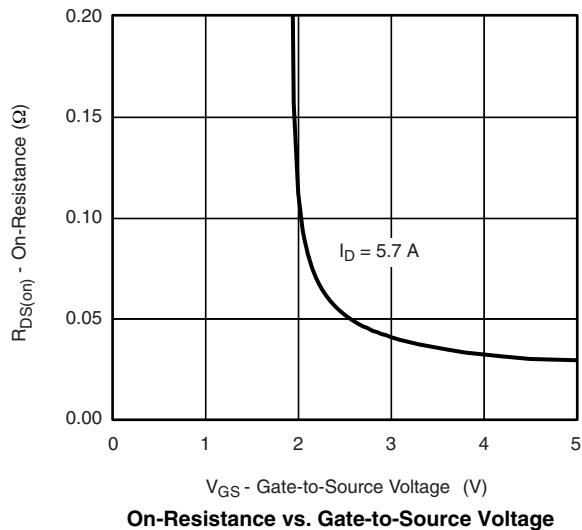
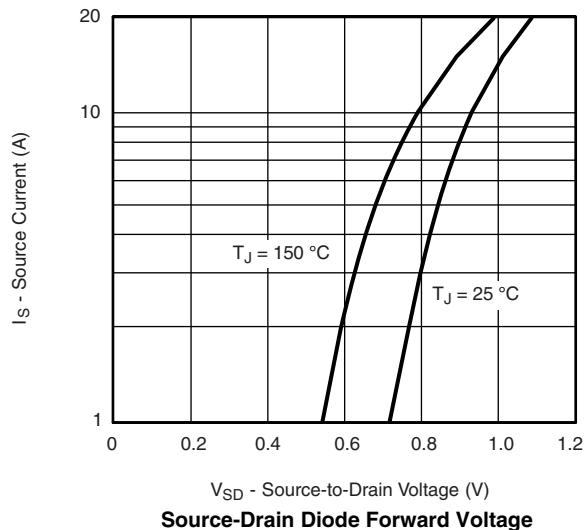
25 °C, unless otherwise noted

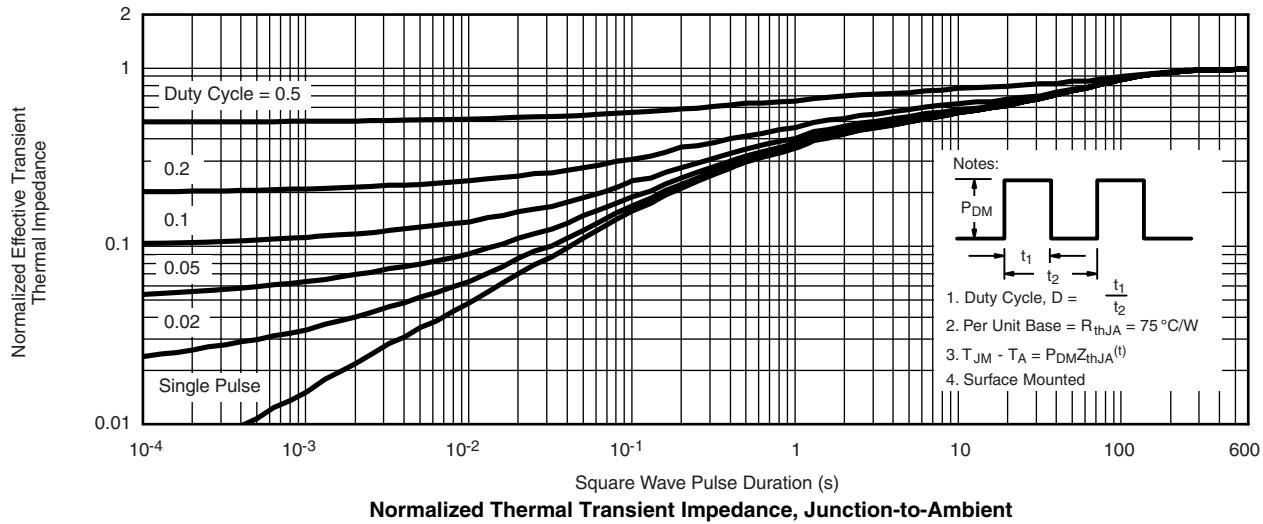


**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

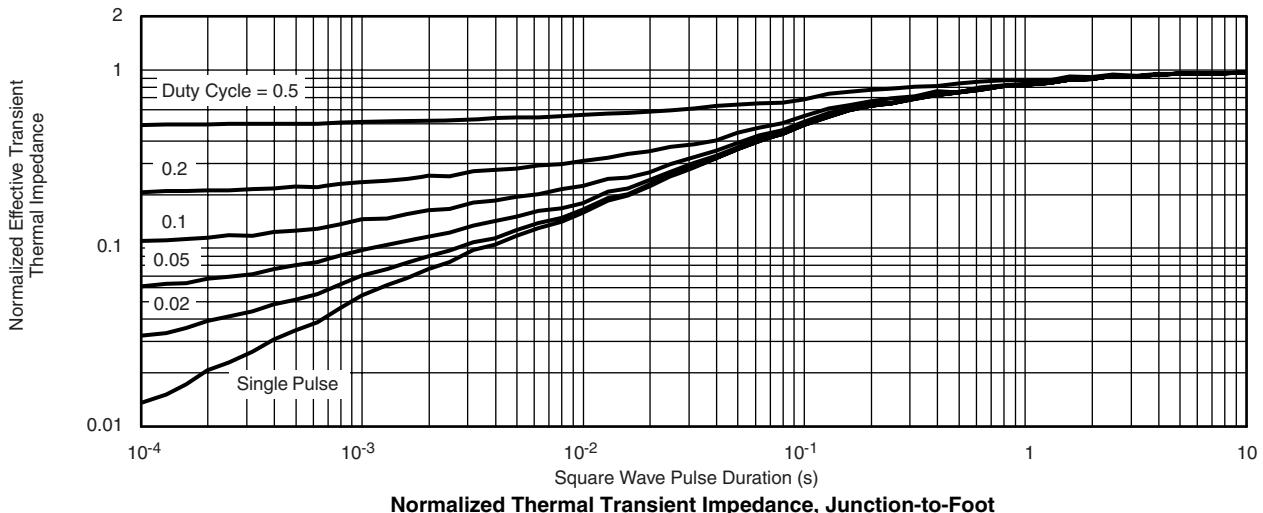
**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Normalized Thermal Transient Impedance, Junction-to-Ambient**

**Normalized Thermal Transient Impedance, Junction-to-Foot**

**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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